

Z-PACK | Z-PACK TinMan TE Internal #: 1934272-1 High Speed Backplane Connectors, 120 Position, Mating Alignment, Guide Slot Mating Alignment Type, 15 Row, 8 Column, PCB Mount Header, Z-PACK TinMan

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors

Connector System: **Board-to-Board** Number of Positions: **120**

Row-to-Row Spacing: 2.5 mm [.098 in]

Mating Alignment: With

Mating Alignment Type: Guide Slot

Features

Product Type Features

Backplane Module Type	Left
Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Partially Shrouded

Connector	&	Contact	Terminates	То
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Printed Circuit Board

Configuration Features

Pairs per Column	5
Number of Pairs	40
Stackable	No
Number of Signal Positions	80
Backplane Architecture	Traditional Backplane
Number of Positions	120
Number of Rows	15
Number of Columns	8
PCB Mount Orientation	Vertical
Electrical Characteristics	
Impedance	100 Ω
Operating Voltage	250 VAC
Signal Characteristics	

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Differential Impedance	100 Ω
Number of Differential Pairs per Column	5
Data Rate	10 Gb/s
Body Features	
Primary Product Color	Black
Contact Features	
Contact Mating Area Length	6 mm[.236 in]
PCB Contact Termination Area Plating Material Thickness	.5 μm[20 μin]
Contact Type	Pin
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Rectangular
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	.5 A

Termination Features

Termination Post & Tail Length	2.5 mm[.098 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Guide Hardware	Without
Mating Retention	Without
PCB Mount Alignment	Without
PCB Mount Retention	With
PCB Mount Retention Type	Action/Compliant Tail
Mating Alignment	With
Mating Alignment Type	Guide Slot
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	2
End Wall Location	Left
Housing Material	LCP (Liquid Crystal Polymer)

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Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	15.35 mm
Connector Height	11.8 mm
Connector Width	24.4 mm
PCB Hole Diameter	.47 mm
Row-to-Row Spacing	2.5 mm[.098 in]
Usage Conditions	
Operating Temperature Range	-65 – 90 °C[-85 – 194 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Agency/Standard	UL
Approved Standards	UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

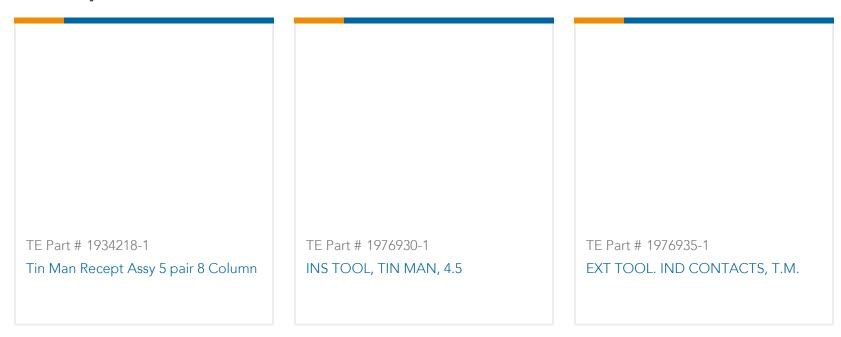
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability
Product Compliance Disclaimer	

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

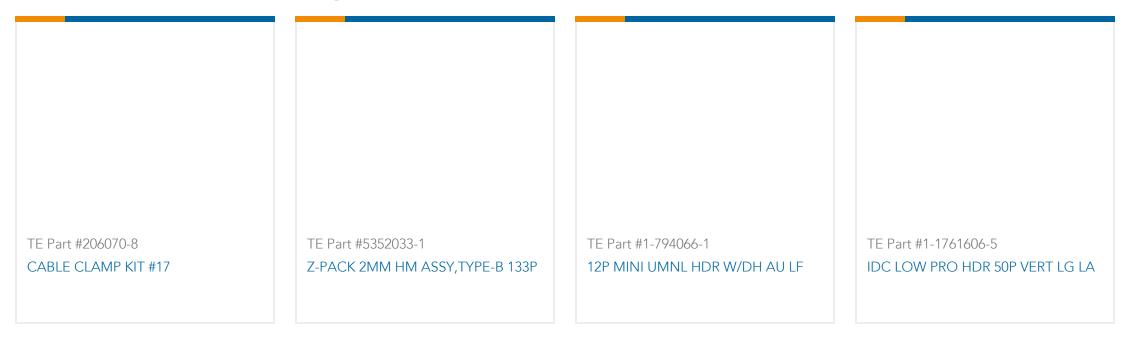
Compatible Parts



Also in the Series Z-PACK TinMan

High Speed Backplane Connectors(65)	Insertion & Extraction Tools(2)
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Customers Also Bought



High Speed Backplane Connectors, 120 Position, Mating Alignment, Guide Slot Mating Alignment Type, 15 Row, 8 Column, PCB Mount Header, Z-PACK TinMan



TE Part #640584-1 08P UMNL HDR ASSY R/A 94VO

Documents

Product Drawings

Tin Man Header Assy 5x8 left

English

CAD Files **Customer View Model** ENG_CVM_1934272-1_B.3d_igs.zip English **Customer View Model**

ENG_CVM_1934272-1_B.3d_stp.zip

English

Customer View Model

ENG_CVM_1934272-1_B.2d_dxf.zip

English

3D PDF

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

Datasheets & Catalog Pages

High Speed Backplane Connectors catalog - Z-PACK TinMan High Speed, High Density Backplane Connector

English

Z-PACK TinMan High Speed High Density Backplane Connector Catalog 5-1773447-9

English

Product Specifications

Application Specification

English

Product Environmental Compliance TE Material Declaration

English